

Datasheet revision 1.0

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Rosin Paste Flux (RA) in 2oz Flat Jar 50 gram

Product Highlights Ideal for all rework, solder, de-solder and wire dipping applications Easily cleaned with Flux Remover or isopropyl alcohol (IPA) Designed for Leaded and Lead-Free applications **RoHS 3 and REACH compliant**

Specifications

Flux Type: Flux Classification: Packaging: Shelf Life: Rosin Activated (for Leaded and Lead-Free applications) ROM1 (Must be cleaned off post-use using Flux Remover or IPA) 2oz Flat Jar 50g Refrigerated >24 months, Unrefrigerated >24 months

Stencil Life

>8 hours @ 20-50% RH 22-28°C (72-82°F) >4 hours @ 50-70% RH 22-28°C (72-82°F)

Stencil Cleaning

Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using flux remover or isopropyl alcohol (IPA).

Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Do not freeze. Allow 4 hours for flux to reach an operating temperature of 20-25°C (68-77°F) before use.

Transportation

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

Conforms to the following Industry Standards: J-STD-004B, Amendment 1 (Solder Fluxes): RoHS 3 Directive (EU) 2015/863:

Yes Yes

